

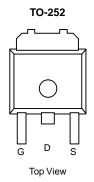
P-Channel 30 V (D-S) MOSFET

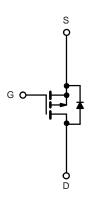
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a		
- 30	0.005 at V _{GS} = - 10 V	-100		
- 30	0.007 at V _{GS} = - 4.5 V	-90		

FEATURES

• Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

ABSOLUTE MAXIMUM RAT	INGS (T _C = 25 °C, unless other	rwise noted)			
Parameter	Symbol	Limit	Unit V		
Gate-Source Voltage	V_{GS}	± 20			
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I _D	- 100 ^a	^	
Continuous Diam Current (1) = 175 C)	T _C = 125 °C		- 90		
Pulsed Drain Current	I _{DM}	- 280	Α		
Avalanche Current	I _{AR}	- 80			
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ	
Power Dissipation	T _C = 25 °C (TO-220AB and TO-263)	В	187 ^d	W	
rower Dissipation	T _A = 25 °C (TO-263) ^c	P_{D}	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^c	В	40			
Junction-to-Ambient	Free Air (TO-220AB)	R _{thJA}	62.5	°C/W		
Junction-to-Case	·	R_{thJC}	0.8			

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. See SOA curve for voltage derating.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.



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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS} $V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		- 30				
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = - 30 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μΑ	
		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 175 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
		V _{GS} = - 10 V, I _D = - 30 A		0.005		Ω	
Drain-Source On-State Resistance ^a	Б	V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.006			
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.008			
		V _{GS} = - 4.5 V, I _D = - 20 A		0.007			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			8000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$		1565			
Reversen Transfer Capacitance	C _{rss}			715			
Total Gate Charge ^c	Q_g			160	240	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -75 \text{ A}$		32			
Gate-Drain Charge ^c	Q_{gd}			30			
Turn-On Delay Time ^c	t _{d(on)}			25	40		
Rise Time ^c	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 0.2 \Omega$		225	360	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 75 A, V_{GEN} = - 10 V, R_g = 2.5 Ω		150	240		
Fall Time ^c	t _f			210	340	1	
Source-Drain Diode Ratings and Cha	racteristics ^b	(T _C = 25 °C)					
Continuous Current	IS				- 80	А	
Pulsed Current	I _{SM}				- 240		
Forward Voltage ^a	V_{SD}	I _F = -75 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			55	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dl/dt = 100 A/μs		2.5	5	Α	
Reverse Recovery Charge	Q _{rr}	1		0.07	0.25	μC	

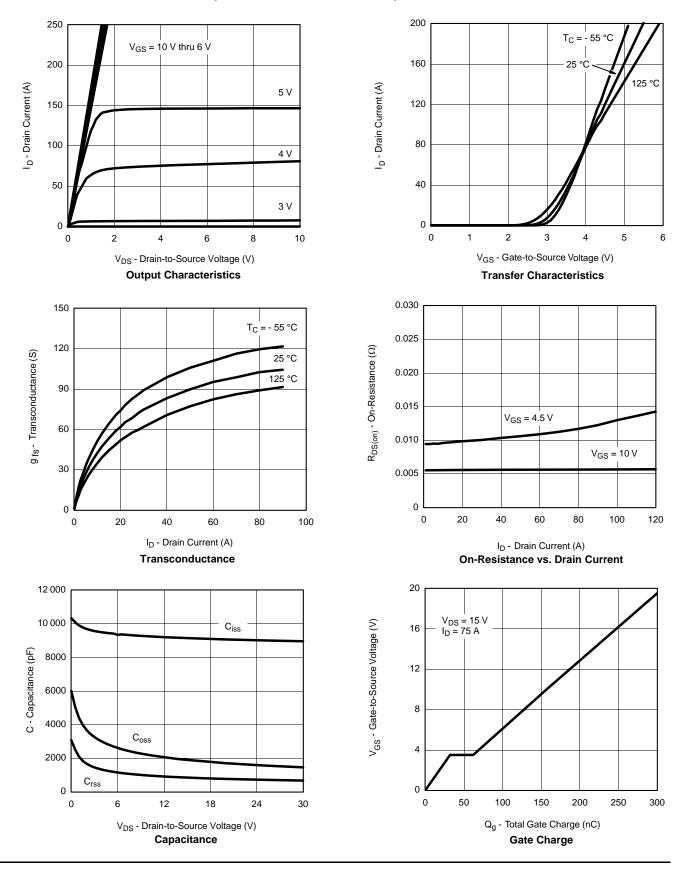
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

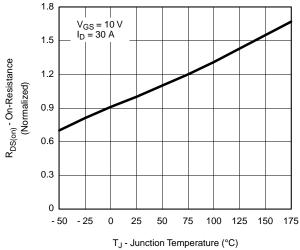


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

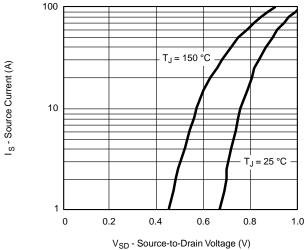




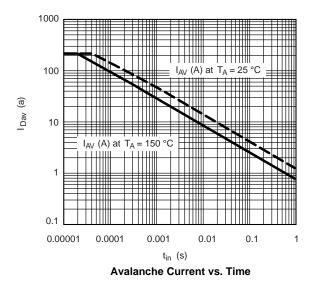
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

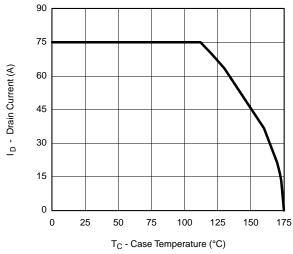


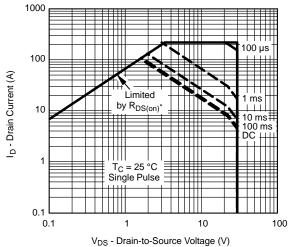
45 I_D = 250 μA 40 30 30 25 - 50 - 25 0 25 50 75 100 125 150 175 T_J - Junction Temperature (°C)

Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS



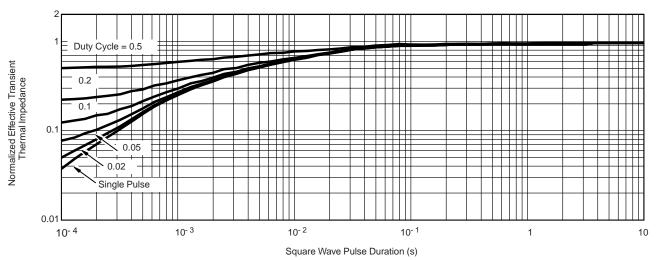


Maximum Avalanche and Drain Current vs. Case Temperature

* V_{GS} - Drain-to-Source Voltage (V)

* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area

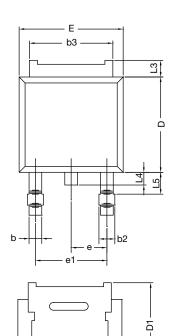


Normalized Thermal Transient Impedance, Junction-to-Case

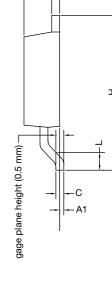
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TO-252AA CASE OUTLINE



E1



C2

	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Ή	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12					

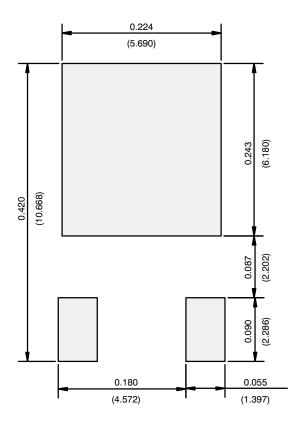
ECN: X12-0247-Rev. M, 24-Dec-1. DWG: 5347

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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